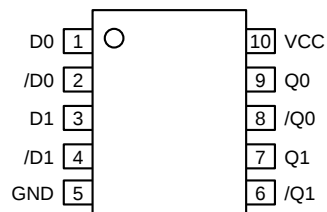


PACKAGE/ORDERING INFORMATION



10-Pin MSOP (K10-1)

Ordering Information⁽¹⁾

Part Number	Package Type	Operating Range	Package Marking	Lead Finish
SY55855VKI	K10-1	Industrial	855V	Sn-Pb
SY55855VKITR ⁽²⁾	K10-1	Industrial	855V	Sn-Pb
SY55855VKG ⁽³⁾	K10-1	Industrial	855V with Pb-Free bar line indicator	NiPdAu Pb-Free
SY55855VKGTR ^(2, 3)	K10-1	Industrial	855V with Pb-Free bar line indicator	NiPdAu Pb-Free

Notes:

1. Contact factory for die availability. Dice are guaranteed at $T_A = 25^\circ\text{C}$, DC Electricals only.
2. Tape and Reel.
3. Pb-Free package recommended for new designs.

PIN DESCRIPTION

Pin Number	Pin Name	Pin Function
1, 2	D0, /D0	CML/PECL/LVPECL Input (Differential). This is one of the inputs. It is converted to LVDS onto the Q0 and /Q0 outputs.
3, 4	D1, /D1	CML/PECL/LVPECL Input (Differential). This is the other input. It is converted to LVDS onto the Q1 and /Q1 outputs.
5	GND	Ground.
6, 7	/Q1, Q1	LVDS Output (Differential). This is the other LVDS output. It buffers the CML input that appears at D1, /D1.
8, 9	/Q0, Q0	LVDS Output (Differential). This is one LVDS output. It buffers the CML input that appears at D0, /D0.
10	V _{CC}	V _{CC}

TRUTH TABLE

D0	D1	Q0	/Q0	Q1	/Q1
0	0	0	1	0	1
0	1	0	1	1	0
1	0	1	0	0	1
1	1	1	0	1	0

FUNCTIONAL DESCRIPTION

Establishing Static Logic Inputs

The true pin of an input pair is internally biased to ground through a 75kΩ resistor. The complement pin of an input pair is internally biased halfway between V_{CC} and ground by a voltage divider consisting of two 75kΩ resistors. In this way, unconnected inputs appear as logic zeros. To keep an input at static logic zero at $V_{CC} > 3.0V$, leave both inputs

unconnected. For $V_{CC} \leq 3.0V$, connect the complement input to V_{CC} and leave the true input unconnected. To make an input static logic one, connect the true input to V_{CC} , leave the complement input unconnected. These are the only two safe ways to cause inputs to be at a static value. In particular, no input pin should be directly connected to ground. All NC (no connect) pins should be unconnected.

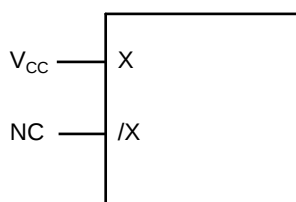


Figure 1. Hard Wiring a Logic “1” (1)

Note 1. X is either D0 or D1 input. /X is either /D0 or /D1 input.

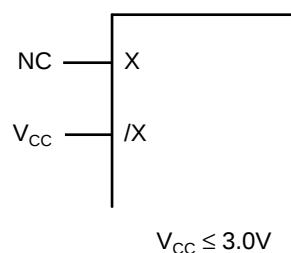
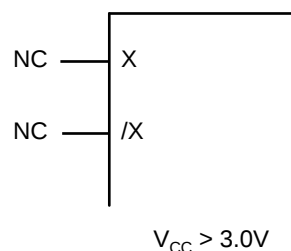


Figure 2. Hard Wiring a Logic “0” (1)

Note 1. X is either D0 or D1 input. /X is either /D0 or /D1 input.

LVDS OUTPUTS

LVDS stands for Low Voltage Differential Swing. LVDS specifies a small swing of 350mV typical, on a nominal 1.25V common mode above ground. The common mode voltage has tight limits to permit large variations in ground between an LVDS driver and receiver. Also, change in common mode voltage, as a function of data input, is also kept tight, to keep EMI low.

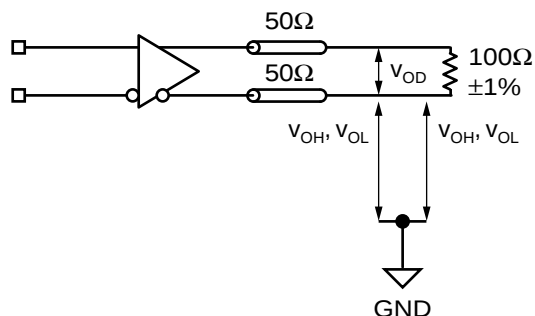


Figure 3. LVDS Differential Measurement

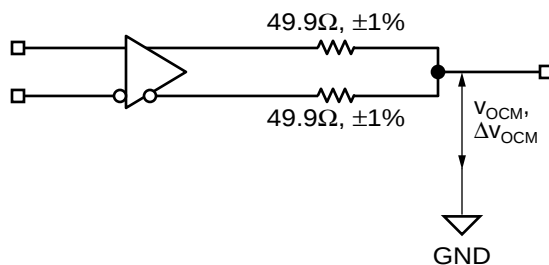


Figure 4. LVDS Common Mode Measurement

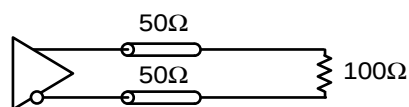


Figure 5. LVDS Output Termination

ABSOLUTE MAXIMUM RATINGS⁽¹⁾

Symbol	Rating	Value	Unit
V_{CC}	Power Supply Voltage	−0.5 to +6.0	V
V_{IN}	Input Voltage	−0.5 to $V_{CC} + 0.5$	V
I_{OUT}	LVDS Output Current	±10%	mA
T_A	Operating Temperature Range	−40 to +85	°C
T_{LEAD}	Lead Temperature (soldering, 20sec.)	260	°C
T_{store}	Storage Temperature Range	−65 to +150	°C

Note 1. Permanent device damage may occur if absolute maximum ratings are exceeded. This is a stress rating only and functional operation is not implied at conditions other than those detailed in the operational sections of this data sheet. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

DC ELECTRICAL CHARACTERISTICS

$V_{CC} = 3.0V$ to $5.7V$; $GND = 0V$; $T_A = -40^{\circ}C$ to $+85^{\circ}C$ ⁽²⁾

Symbol	Parameter	$T_A = -40^{\circ}C$		$T_A = +25^{\circ}C$			$T_A = +85^{\circ}C$		Unit
		Min.	Max.	Min.	Typ.	Max.	Min.	Max.	
V_{CC}	Power Supply Voltage	3.0	5.7	3.0	—	5.7	3.0	5.7	V
I_{CC}	Power Supply Current								mA
	$3.6V < V_{CC} < 5.7V$	—	80	—	—	80	—	80	
	$V_{CC} \leq 3.6V$	—	50	—	30	50	—	50	

CML DC ELECTRICAL CHARACTERISTICS

$V_{CC} = 3.0V$ to $5.7V$; $GND = 0V$; $T_A = -40^{\circ}C$ to $+85^{\circ}C$ ⁽²⁾

Symbol	Parameter	Min.	Typ.	Max.	Unit	Condition
V_{ID}	Differential Input Voltage	100	—	—	mV	
V_{IH}	Input HIGH Voltage	1.6	—	V_{CC}	V	
V_{IL}	Input LOW Voltage	1.5	—	$V_{CC} - 0.1$	V	

LVDS DC ELECTRICAL CHARACTERISTICS

$V_{CC} = 3.0V$ to $5.7V$; $GND = 0V$; $T_A = -40^{\circ}C$ to $+85^{\circ}C$ ⁽²⁾

Symbol	Parameter	Min.	Typ.	Max.	Unit	Condition
V_{OD}	Differential Output Voltage ⁽⁴⁾	250	—	450	mV	100Ω Termination
V_{OCM}	Output Common Mode Voltage ⁽³⁾	1.125	—	1.375	V	
ΔV_{OCM}	Change in Common Mode Voltage ⁽³⁾	−50	—	+50	mV	
V_{OH}	Output HIGH Voltage ^{(4), (5)}	—	—	1.474	V	$I_{OH} = -4.0mA$
V_{OL}	Output LOW Voltage ^{(4), (5)}	0.925	—	—	V	$I_{OL} = 4.0mA$

Note 2. Equilibrium temperature.

Note 3. Measured as per Figure 4.

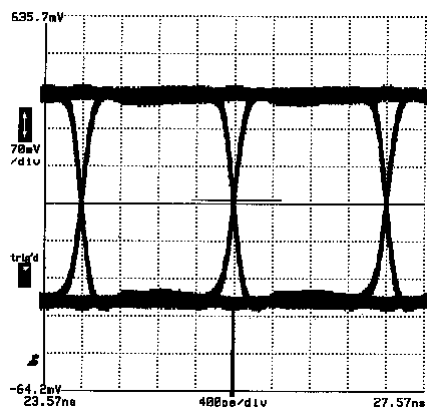
Note 4. Measured as per Figure 3.

Note 5. Do not short output to GND.

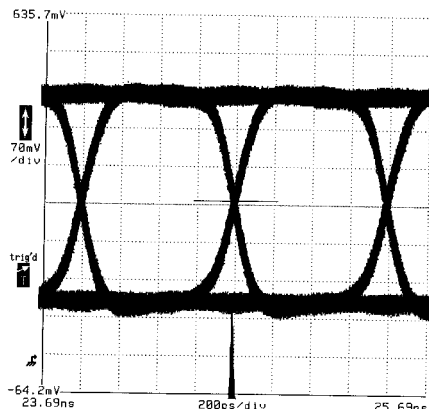
AC ELECTRICAL CHARACTERISTICS⁽¹⁾ $V_{CC} = 3.0V$ to $5.7V$; $GND = 0V$; $T_A = -40^{\circ}C$ to $+85^{\circ}C$ ⁽²⁾

Symbol	Parameter	Min.	Typ.	Max.	Unit	Condition
f_{MAX}	Maximum Operating Frequency	750	—	—	MHz	
t_{PLH} t_{PHL}	Propagation Delay D0 to Q0, D1 to Q1	300	—	700	ps	
t_{SKEW}	Within-Device Skew ⁽³⁾ Part-to-Part Skew (Diff.)	— —	— —	50 250	ps	
t_r t_f	LVDS Output Differential Rise/Fall Times (20% to 80%)	100	—	300	ps	

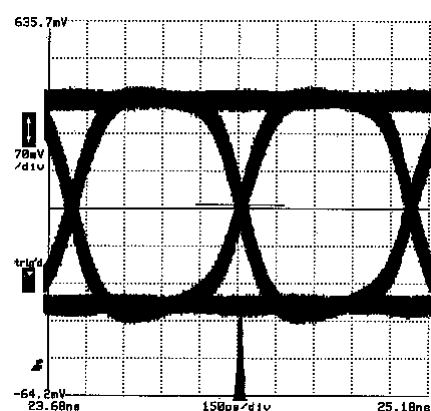
Note 1. Specification for packaged product only.**Note 2.** Equilibrium temperature.**Note 3.** Worst case difference between Q0 and Q1 from either D0 or D1, when both outputs have the same transition.

EYE DIAGRAMS⁽¹⁾

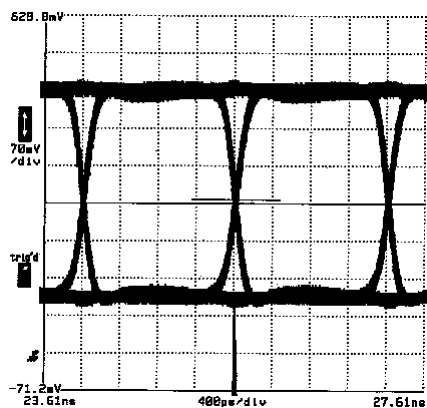
**622Mbps
3.3V LVPECL-to-LVDS**



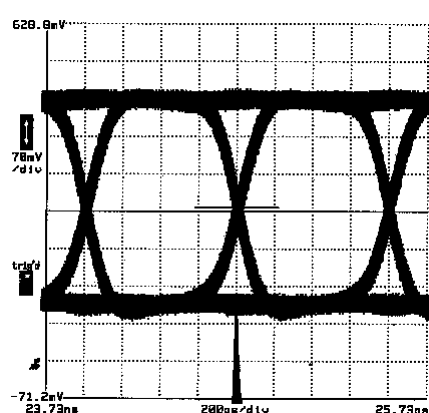
**1.25Gbps
3.3V LVPECL-to-LVDS**



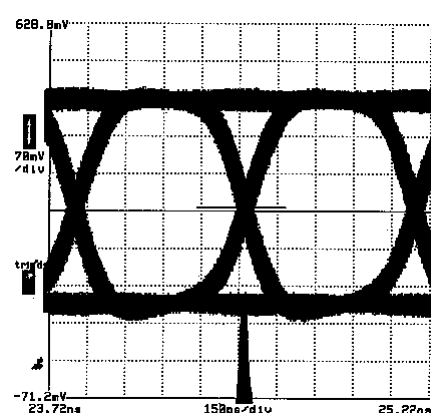
**1.5Gbps
3.3V LVPECL-to-LVDS**



**622Mbps
3.3V CML-to-LVDS**

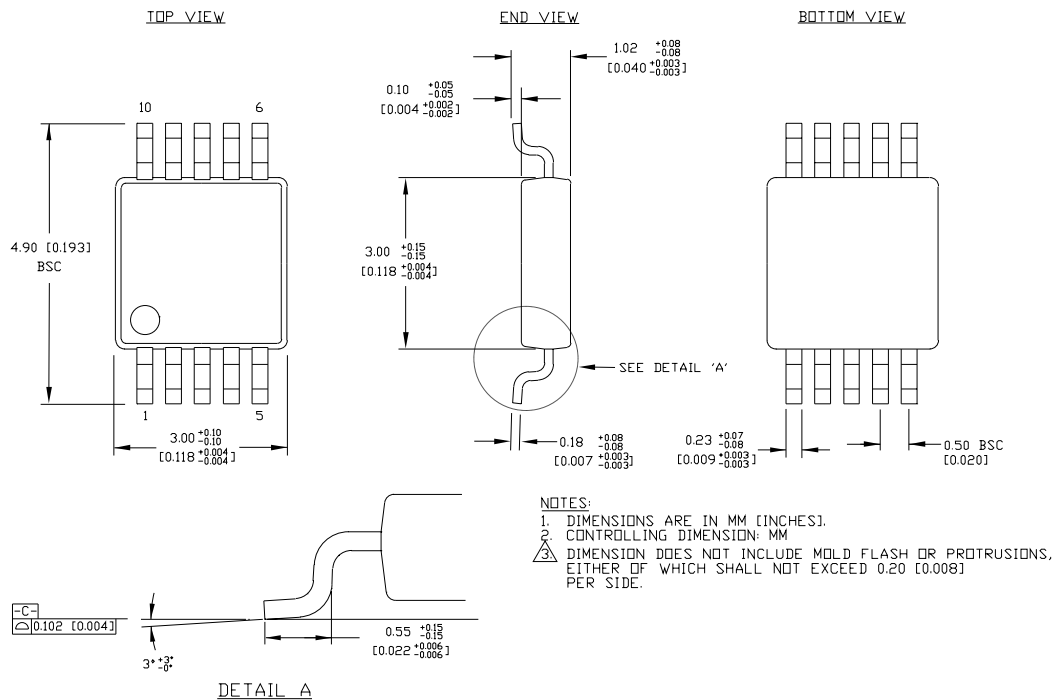


**1.25Gbps
3.3V CML-to-LVDS**



**1.5Gbps
3.3V CML-to-LVDS**

Note 1. $2^{23}-1$ pattern.

10-PIN MSOP (K10-1)

Rev. 00

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